



ELS-810-638

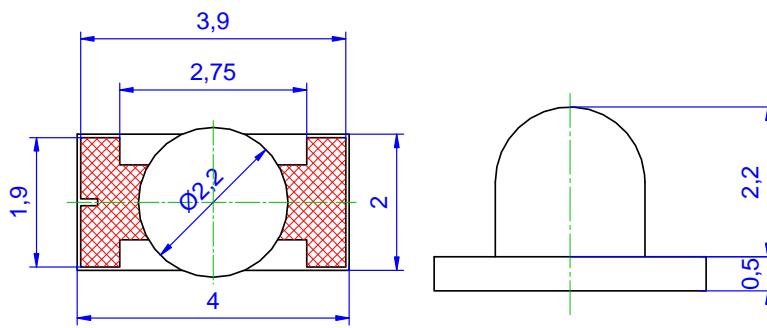
Radiation	Type	Technology	Case
Infrared	SMD - LED on silicon carrier	AlGaAs/AlGaAs	waterclear, plastic lens

Description

High-power, double-hetero AlGaAs structure with removed substrate on heatsink for „up side down“ mounting

Applications

Photoelectric barriers, remote controls, illumination for CCD-cameras and night-vision systems, alarm guard systems, fibre optics



all dimensions in mm, tolerance: $\pm 0,05$ mm

Maximum Ratings

$T_{amb} = 25^\circ\text{C}$, unless otherwise specified

Parameter	Test conditions	Symbol	Value	Unit
DC forward current	on heatsink	I_F	250	mA
Peak forward current	$t_p \leq 10 \mu\text{s}, f \leq 500 \text{ Hz}$	I_{FRM}	2000	mA
Reverse voltage	$I_R = 10 \mu\text{A}$	V_R	5	V
Operating temperature range		T_{amb}	-25 to +85	°C
Junction temperature		T_{jmax}	100	°C

Optical and Electrical Characteristics

$T_{amb} = 25^\circ\text{C}$, unless otherwise specified

Parameter	Test conditions	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F = 100 \text{ mA}$	V_F		1.75		V
Forward voltage	$I_F = 250 \text{ mA}$	V_F		2.2		V
Radiant power	$I_F = 100 \text{ mA}$	Φ_e		17		mW
Peak wavelength	$I_F = 100 \text{ mA}$	λ_p	790	810	830	nm
Spectral bandwidth at 50%	$I_F = 100 \text{ mA}$	$\Delta\lambda_{0.5}$		30		nm
Viewing angle	$I_F = 100 \text{ mA}$	φ		30	35	deg
Switching time	$I_F = 100 \text{ mA}$	t_r, t_f		30		ns
Temperature coefficient of forward voltage	$I_F = 100 \text{ mA}$	TKV_F		-2		mV/K
Thermal resistance junction/heatsink	$I_F = 100 \text{ mA}$	R_{th}		50		K/W